

承認書

SPECIFICATION FOR APPROVAL

Customer Name: 2144

Description Part No.: _____

Customer Part No.: _____

Sample No.: _____

DDY Part No.: SFE252010S-

DRAWING		
MADE	CHECKED	APPROVED
王海玲	赵万虎	肖中华
DATE: 2023年4月22日		

CUSTOMER APPROVE



惠州市德立电子有限公司

HUI ZHOU DE LI ELECTRONICS CO., LTD

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Version of Changed Record

[illegible]

*** Special notes:**
This product is non-vehicle certified.



1. Scope

This specification applies to the SFE252010 Series of wire wound SMD power inductor.

2.PRODUCT IDENTIFICATION

SFE 252010 - 1R5 □ - □

(1) (2) (3) (4) (5)

(1) .Series name (产品品名)

(2) .Dimensions (产品尺寸)

(3) .Inductance value (电感值)

(4) .Tolerance (误差值)

1R5: 1.5 μ H 221: 220 μ H

M: $\pm 20\%$; N: $\pm 30\%$

(5) .Environmental status (环保状态)

LF- Lead free; HF-Halogen free.

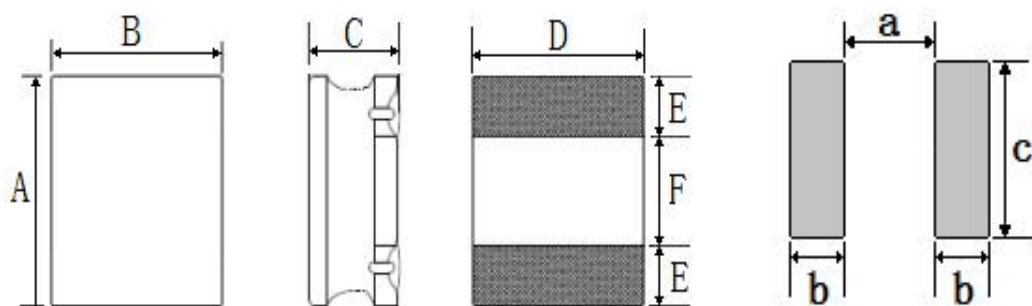
FP-Free red phosphor.

3. Electrical Characteristics

Please refer to Item 5.

- 1). Operating temperature range (individual chip without packing): $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$.
- 2). Storage temperature range (packaging conditions): $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$ and RH 70% (Max.).
- 3). Rating DC current: Temperature rise(ΔT) is 40°C approximately at Irms.
- 4). Saturation DC current: Inductance drop approximately 30% of L_0 at Isat.

4. Shape and Dimensions (Unit:mm)



Recommended Land Pattern

NO	Series	A	B	C	D	E	F	a Typ.	b Typ.	c Typ.
1	SFE252010	2.5 ± 0.3	2.0 ± 0.3	1.0 Max.	2.0 ± 0.2	0.75 Typ.	1.0 Typ.	0.80	0.90	2.2



5. Electrical Characteristics

NO	DDY CODE	Part Number	Inductance	DC Resistance		Isat(A)		Irms(A)		Marking
			100KHz/1.0V	Max.	Typ.	Max.	Typ.	Max.	Typ.	
		Units	(uH)	Ω	Ω	A	A	A	A	
1		□ SFE252010S-R24N-HF	0.24±30%	0.034	0.026	3.60	4.40	2.75	3.00	N/A
2		□ SFE252010S-R33N-HF	0.33±30%	0.040	0.033	3.60	4.30	2.45	2.70	N/A
3		□ SFE252010S-R47M	0.47±30%	0.044	0.035	2.80	3.20	2.40	2.60	N/A
4		□ SFE252010S-R56N-HF	0.56±30%	0.052	0.044	2.80	3.10	2.30	2.50	N/A
5		□ SFE252010S-R68N-HF	0.68±30%	0.062	0.051	2.75	3.10	2.10	2.35	N/A
6		□ SFE252010S-1R0M-HF	1.0±30%	0.080	0.066	2.05	2.50	1.85	2.05	N/A
7		□ SFE252010S-1R5N-HF	1.5±30%	0.108	0.085	1.70	2.05	1.55	1.70	N/A
8		□ SFE252010S-1R8N-HF	1.8±30%	0.150	0.126	1.70	2.05	1.55	1.70	N/A
9		□ SFE252010S-2R2M-HF	2.2±20%	0.150	0.126	1.60	2.00	1.50	1.70	N/A
10		□ SFE252010S-3R3M-HF	3.3±20%	0.228	0.201	1.10	1.35	1.05	1.20	N/A
11		□ SFE252010S-4R7M-HF	4.7±20%	0.330	0.248	1.00	1.15	0.90	1.00	N/A
12		□ SFE252010S-5R6M-HF	5.6±20%	0.480	0.310	0.90	1.05	0.80	0.90	N/A
13		□ SFE252010S-6R8M-HF	6.8±20%	0.480	0.438	0.80	0.95	0.72	0.80	N/A
14		□ SFE252010S-8R2M-HF	8.2±20%	0.572	0.440	0.73	0.85	0.69	0.78	N/A
15		□ SFE252010S-100M	10±20%	0.600	0.500	0.65	0.75	0.65	0.75	N/A
16		□ SFE252010S-120M-HF	12±20%	0.850	0.700	0.58	0.62	0.58	0.62	N/A
17		□ SFE252010S-150M-HF	15±20%	1.050	0.710	0.50	0.55	0.45	0.50	N/A
18		□ SFE252010S-220M-HF	22±20%	1.344	1.233	0.40	0.45	0.32	0.38	N/A

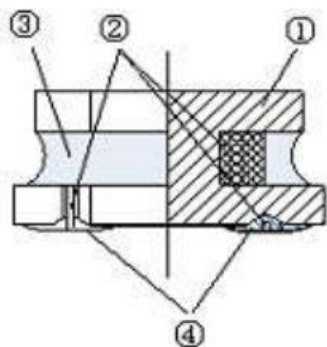
※Design as Customer's Requested Specifications. (可按顾客的特殊需求设计)



惠州市德立电子有限公司

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6. Structure (The structure of product.)



NO	Components	Material
①	Core	Ni-Zn Ferrite
②	Wire	Polyurethane system enameled copper wire
③	Magnetic Glue	Epoxy resin and magnetic powder
④	Plating	AgNiSn or FeNiCu + Sn Alloy

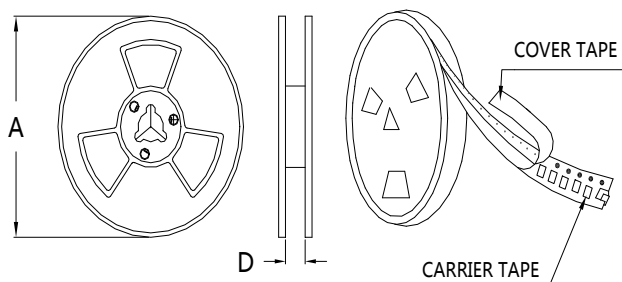
7. PACKAGING(unit: mm)

1.包装类型：编带装

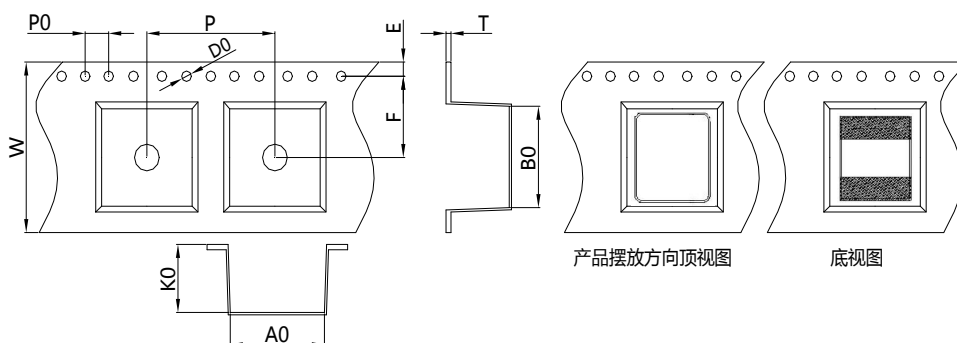
2.包装尺寸：

☐ 13" 盘

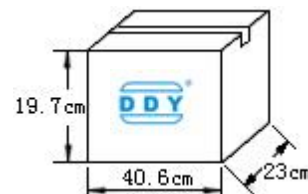
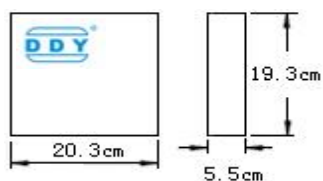
☒ 7" 盘



	13" 盘	7" 盘
A	$\Phi 330 \pm 2.0$	$\Phi 178 \pm 2.0$
D	8.5	



Size	Item	W	A0	B0	K0	P	T	E	F	D0	P0
252010	(mm)	8.00 ± 0.3	2.35 ± 0.2	2.65 ± 0.2	1.40 ± 0.1	4.00 ± 0.1	0.25 ± 0.1	1.75 ± 0.1	3.50 ± 0.1	1.50 ± 0.1	4.00 ± 0.2



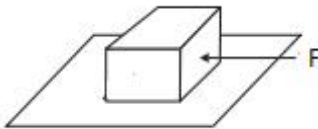
每卷	2000	Pcs
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每盒	4卷,共	8000	Pcs
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每箱	6盒,共	48000	Pcs
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8. RELIABILITY TEST

No.	TEST ITEM	SPECIFICATION	TEST CONDITION
1	High temperature Storage test	1. No significant defects in appearance. 2. $\Delta L/L \leq 10\%$ 3. $\Delta DCR/DCR \leq 10\%$	Temperature: $125^{\circ}\text{C} \pm 5^{\circ}\text{C}$ (N: Follow the product specification for the setting.) Time : 96 ± 2 hours Place the samples for one hour at room temperature and test them within two hours
2	Low temperature Storage test	1. No significant defects in appearance. 2. $\Delta L/L \leq 10\%$ 3. $\Delta DCR/DCR \leq 10\%$	Temperature: $-40^{\circ}\text{C} \pm 5^{\circ}\text{C}$ (M: Follow the product specification for the setting) Time : 96 ± 2 hours Place the samples for one hour at room temperature and test them within two hours.
3	Humidity test	1. No significant defects in appearance. 2. $\Delta L/L \leq 10\%$ 3. $\Delta DCR/DCR \leq 10\%$	Temperature: $40 \pm 2^{\circ}\text{C}$, Humidity: $93 \pm 3\% \text{RH}$ Time : 96 ± 2 hours Place the samples for one hour at room temperature and test them within two hours
4	Solderability test	Terminals must have 95% minimum solder coverage	1. Dip pads in flux then dip in solder pot at $245 \pm 5^{\circ}\text{C}$ for 5 second. 2. Solder: lead free 3. Flux: rosin flux
5	Heat endurance of flow soldering	1. No significant defects in appearance. 2. $\Delta L/L \leq 10\%$ 3. $\Delta DCR/DCR \leq 10\%$	1. Refer to the above reflow curve and go through the reflow for twice. 2. The peak temperature : $260 + 0/-5^{\circ}\text{C}$
6	Vibration test	1. No significant defects in appearance. 2. No short and no open.	Apply frequency 10~55~10Hz and amplitude 1.5mm, 1 min/cycle in X Y and Z direction for 2 hours each. (total 6 hours)
7	Terminal strength push test	1. Applied force: 10N Duration: 10sec 2. Solder paste thickness: 0.12mm 3. Meet the above requirements without any loose termina	Solder the test samples to the PCB through 245°C reflow, apply a standard force on the side of the test samples for 10 seconds. 



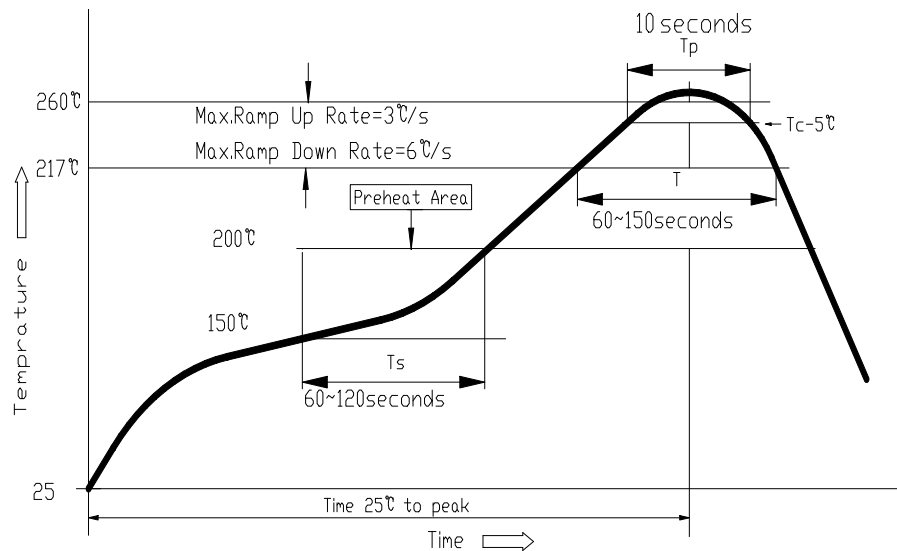
9. SOLDERING CONDITIONS

Applicable soldering process to the products is refl.

9.1 Soldering Materials

- (1) Solder: Sn-3.0Ag-0.5Cu
- (2) Flux: Use rosin-based flux, but not strongly acidic flux (with xhlorine exceeding 0.2wt%). Do not use water-soluble flux.

9.2 Reflow Soldering Profile



9.3 Soldering Iron

Reworking with electric soldering iron must preheating at 150°C for 1 minute is required, and do not directly touch the core with the tip of the soldering iron. The reworking soldering conditions are as follows.

- ① Temperature of soldering iron tip: 350°C ;
- ② Soldering iron power output: $\leq 30\text{W}$;
- ③ Diameter of soldering iron end: $\leq 1.0\text{mm}$;
- ④ Soldering time: $< 3\text{s}$

